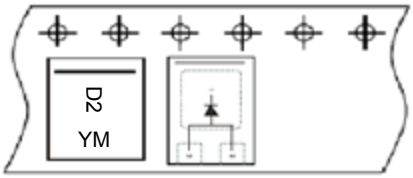
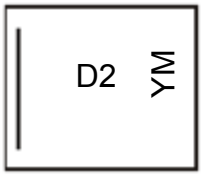
Marking Information





D2 = Product Type Marking Code
YM = Date Code Marking
Y = Year (ex: B = 2014)
M = Month (ex: 6 = June)
Bar = Cathode

Date Code Key

Year	2014	2015	2016	2017	2018	2019	2020	2021	2022
Code	B	C	D	E	F	G	H	I	J

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_{RM}	15	V
Average Rectified Output Current	I_O	2	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I_{FSM}	25	A

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Typical Thermal Resistance Junction to Case (Note 5)		$R_{\theta JC}$	25	°C/W
Typical Thermal Resistance Junction to Ambient (Note 5)		$R_{\theta JA}$	100	°C/W
Operating Temperature Range	$V_R \le 80\%\ V_{RRM}$ $V_R \le 50\%\ V_{RRM}$ DC Forward Mode (Note 7)	T_J	-55 to +150 ≤ +175 ≤+200	°C
Storage Temperature Range		T_{STG}	-55 to +150	°C

Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop (Note 6)	V_F	—	—	0.48	V	I_F = 2A, T_J = +25°C
Leakage Current (Note 6)	I_R	— —	— 5.7	100 —	μA mA	V_R = 15V, T_J = +25°C V_R = 15V, T_J = +125°C

Notes: 5. Device mounted on FR-4 PCB pad layout 1-inch 2oz copper.
6. Short duration pulse test used to minimize self-heating effect.
7. Max junction temperature guaranteed for two hours.

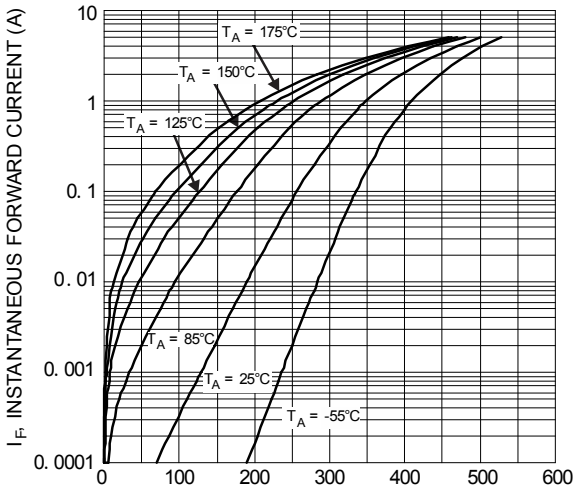


Figure 1 Typical Forward Characteristics

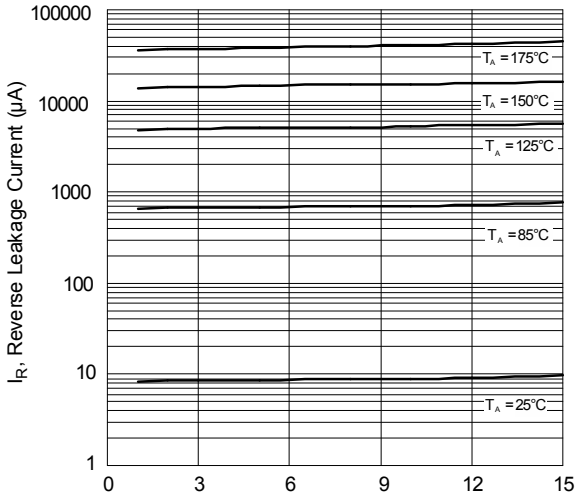


Figure 2 Typical Reverse Characteristics

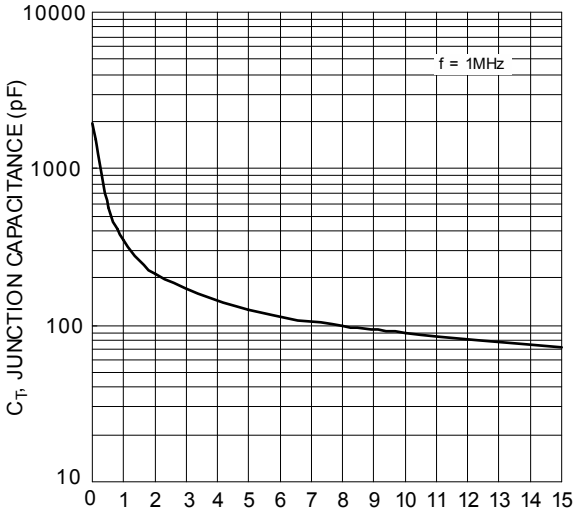


Figure 3 Typical Junction Capacitance

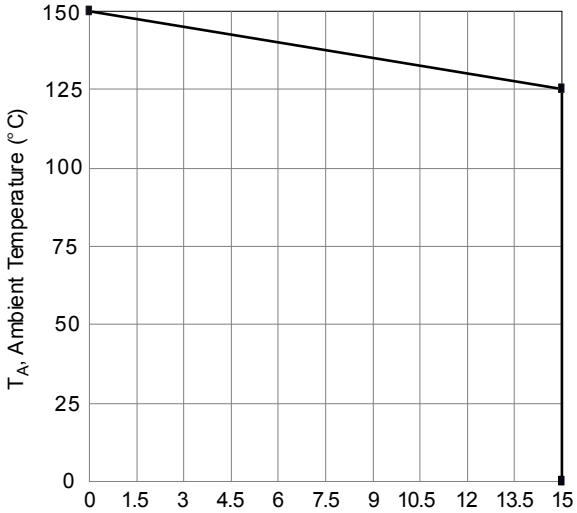


Figure 4 Operating Temperature Derating

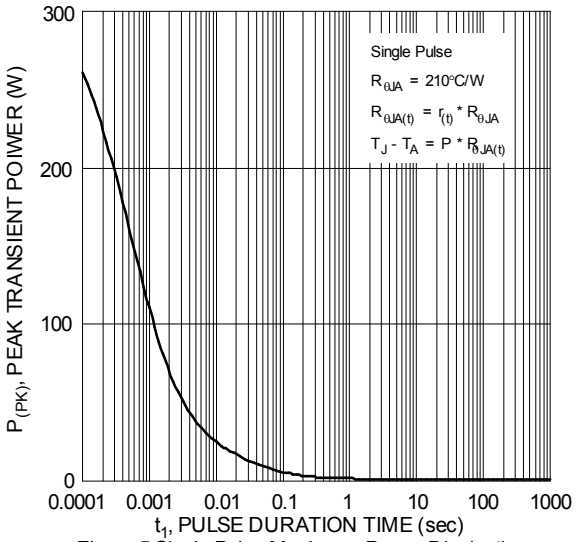


Figure 5 Single Pulse Maximum Power Dissipation

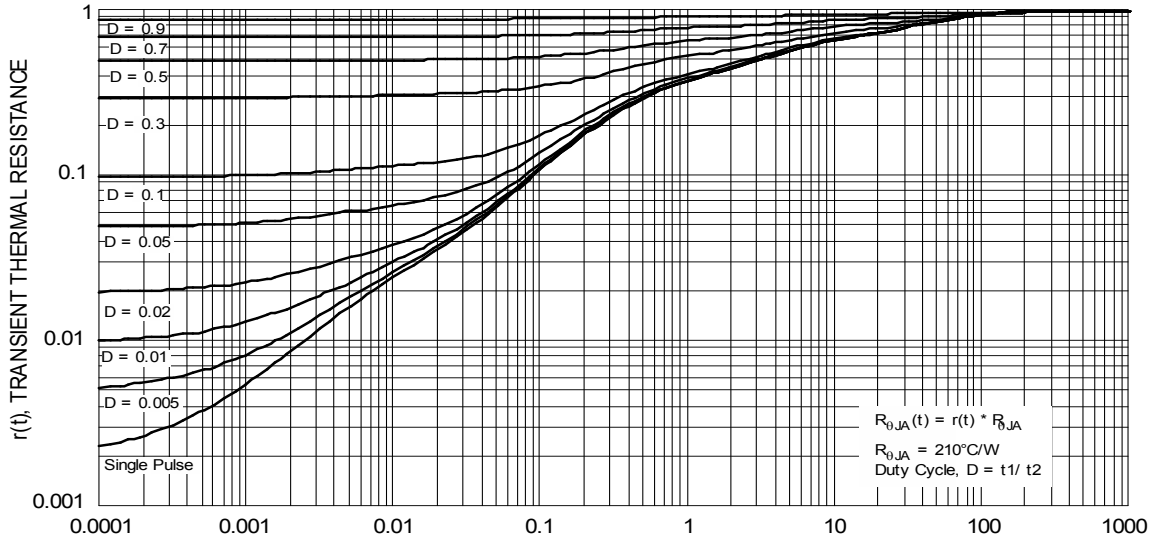
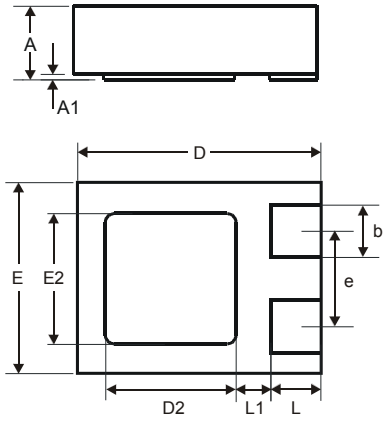


Figure 6 Transient Thermal Resistance

Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X1-DFN1411-3

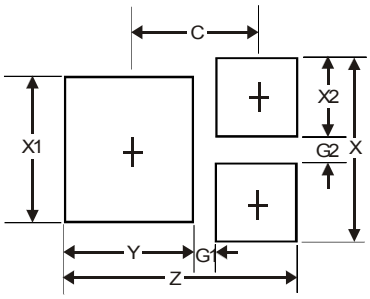


X1-DFN1411-3			
Dim	**Min**	**Max**	**Typ**
A	0.47	0.53	0.50
A1	0	0.05	0.02
b	0.25	0.35	0.30
D	1.35	1.475	1.40
D2	0.65	0.85	0.75
E	1.05	1.175	1.10
E2	0.65	0.85	0.75
e	-	-	0.55
L	0.225	0.325	0.275
L1	-	-	0.20
All Dimensions in mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X1-DFN1411-3



Dimensions	Value (in mm)
Z	1.38
G1	0.15
G2	0.15
X	0.95
X1	0.75
X2	0.40
Y	0.75
C	0.76

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